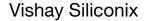
# SiHP15N65E

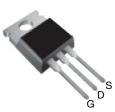


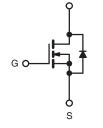


# **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.28			
Q <sub>g</sub> max. (nC)	96				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	21				
Configuration	Single				

## TO-220AB





N-Channel MOSFET

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of
- compliance please see <u>www.vishay.com/doc?99912</u> Note
- <sup>6</sup> This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
    - Induction heating
    - Motor drives
    - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP15N65E-E3
Lead (Pb)-free and Halogen-free	SiHP15N65E-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	650	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	V		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	15			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		10	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	38			
Linear Derating Factor				1.4	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	286	mJ		
Maximum Power Dissipation			PD	34	W		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		-l) / / -lt	37			
Reverse Diode dV/dt <sup>d</sup>			dV/dt	23	V/ns		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.5 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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HALOGEN



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		0.7	°C/W			
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	0111202						110 0 11	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	Vcs	= 0 V, I <sub>D</sub> =	250 µA	650	-	_	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			, I <sub>D</sub> = 1 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> =	-	2	-	4	V
	VGS(th)	-			-	_	+ ± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$		-	-		
		$V_{GS} = \pm 30 \text{ V}$				-	± 1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA	
Ducia Course Or Otata Decistance		$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 \text{ °C}$		-	-	10	0	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		$I_D = 8 A$	-	0.23	0.28	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub>	<sub>s</sub> = 30 V, I <sub>D</sub>	= 8 A	-	5.6	-	S
Dynamic		T			1	1		r —
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to 520 V}, V_{GS} = 0 V$		-	1640	-	pF	
Output Capacitance	Coss			-	80	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>			-	63	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	213	-		
Total Gate Charge	Qg				-	48	96	1
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 8 A, V <sub>DS</sub> = 520 V		-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	21	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	36	1
Rise Time	t <sub>r</sub>				-	24	48	1
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 8 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$ $f = 1 \text{ MHz, open drain}$		-	48	96	ns Ω	
Fall Time	t <sub>f</sub>			-	25	50		
Gate Input Resistance	R <sub>g</sub>			-	0.8	-		
Drain-Source Body Diode Characteristic			-					·
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	MOSFET symbol		-	-	15	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	38	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 8 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	0.0	, 0		-	325	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 8 \text{ A,}$ dl/dt = 100 A/µs, V <sub>R</sub> = 400 V		_	4.6	-	μΟ	
Reverse Recovery Current	I <sub>RRM</sub>			-	20	-	μ0 A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

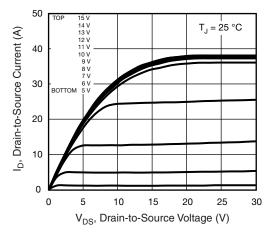


Fig. 1 - Typical Output Characteristics

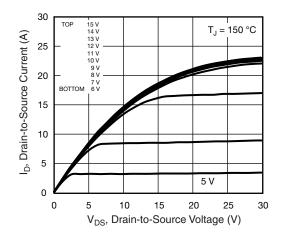


Fig. 2 - Typical Output Characteristics

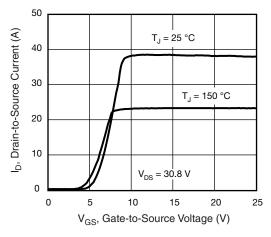


Fig. 3 - Typical Transfer Characteristics

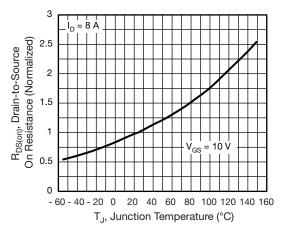


Fig. 4 - Normalized On-Resistance vs. Temperature

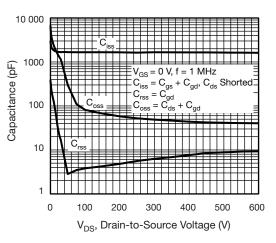


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

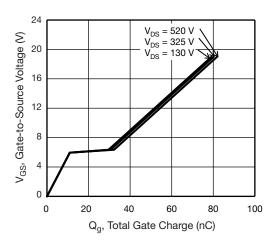


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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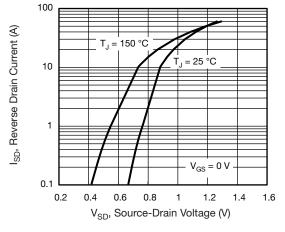
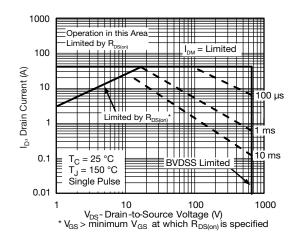


Fig. 7 - Typical Source-Drain Diode Forward Voltage





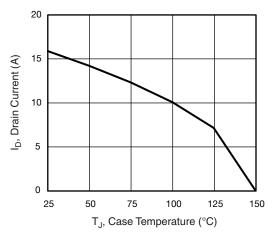


Fig. 9 - Maximum Drain Current vs. Case Temperature

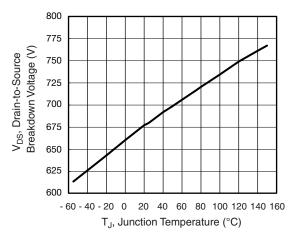
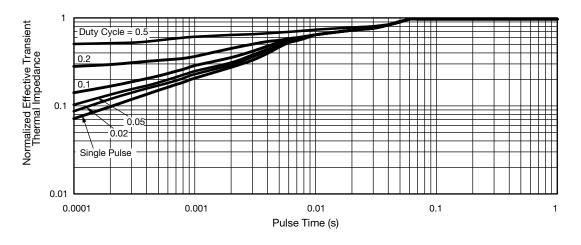


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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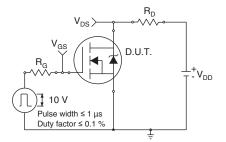


Fig. 12 - Switching Time Test Circuit

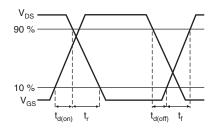


Fig. 13 - Switching Time Waveforms

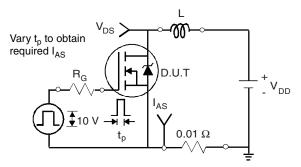


Fig. 14 - Unclamped Inductive Test Circuit

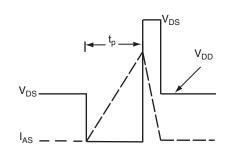
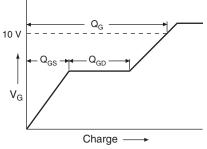


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

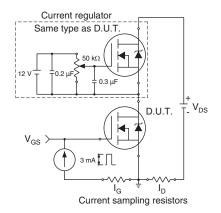


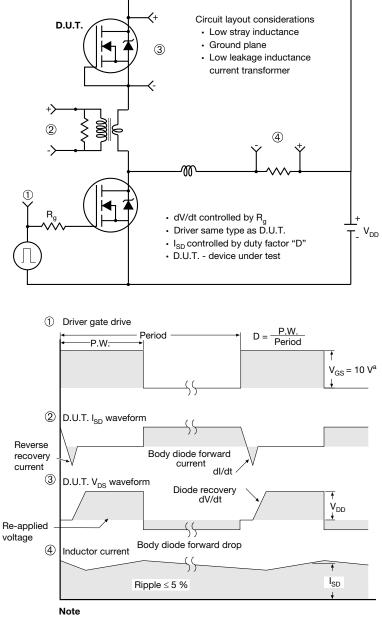
Fig. 17 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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